

## **Application Data Sheet**

### **Application Information**

Application Type::	Regular
Subject Matter::	Utility
Title::	Semiconductor multipackage module including processor and memory package assemblies
Attorney Docket Number::	CPAC 1041-2
Suggested Drawing Figure::	
Total Drawing Sheets::	
Small Entity?::	No

### **Applicant Information**

Applicant Authority Type:	Inventor
Primary Citizenship Country:	US
Status:	Full Capacity
Given Name:	Marcos
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City of Residence:	Palo Alto
State or Province of Residence:	CA
Country of Residence:	US
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City of mailing address:	Palo Alto
State or Province of mailing address:	CA
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## Correspondence Information

Correspondence Customer Number:: 22470

## Representative Information

Representative Customer Number::	22470	
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## Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	An application claiming the benefit under 35 USC 119 (e)	60460541	June 4, 2003

## Assignee Information

Assignee name:: ChipPAC, Inc  
Street of mailing address:: 47400 Kato Road  
City of mailing address:: Fremont  
State or Province of mailing address:: CA  
Country of mailing address:: US  
Postal or Zip Code of mailing address:: 94538